# Regulation, Scheme and syllabus for B.Voc Degree Programme in Electronics Manufacturing Services

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#### 1. Introduction

It has been a long felt necessity to align higher education with the emerging needs of the economy so as to ensure that the graduates of higher education system have adequate knowledge and skills for employment and entrepreneurship. The higher education system has to incorporate the requirements of various industries in its curriculum, in an innovative and flexible manner while developing a holistic and well groomed graduate.

Under the National Skills Development Corporation, many Sector Skill Councils representing respective industries have/are being established. One of the mandates of Sector Skill Councils is to develop National Occupational Standards (NOSs) for various job roles in their respective industries. It is important to embed the competencies required for specific job roles in the higher education system for creating employable graduates.

The University Grants Commission (UGC) has launched a scheme on skills development based higher education as part of college/university education, leading to Bachelor of Vocation (B.Voc.) Degree with multiple exits such as Diploma/Advanced Diploma under the NSQF. The B.Voc. programme is focused on universities and colleges providing undergraduate studies which would also incorporate specific job roles and their NOSs alongwith broad based general education. This would enable the graduates completing B.Voc. to make a meaningful participation in accelerating India's economy by gaining appropriate employment, becoming entrepreneurs and creating appropriate knowledge.

#### 2. Objectives

- **2.1** To provide judicious mix of skills relating to a profession and appropriate content of General Education.
- **2.2** To ensure that the students have adequate knowledge and skills, so that they are work ready at each exit point of the programme.
- **2.3** To provide flexibility to the students by means of pre-defined entry and multiple exit points.
- **2.4** To integrate NSQF within the undergraduate level of higher education in order to enhance employability of the graduates and meet industry requirements. Such graduates apart from meeting the needs of local and national industry are also expected to be equipped to become part of the global workforce.
- **2.5** To provide vertical mobility to students coming out of 10+2 with vocational subjects.

## 3. Levels of Awards

The certification levels will lead to Diploma/Advanced Diploma/B. Voc. Degree in one or more vocational areas and will be offered under the aegis of the University. This is out-lined in Table I.

Awards	Award Duration	Corresponding NSQF level
Diploma	1 Year	5
Advanced Diploma	2 Years	6
B.Voc. Degree	3 Years	7

Table I: Awards

### 4. Eligibility for admission in B.Voc

The eligibility condition for admission to B.Voc.programme shall be 10+2 or equivalent, in any stream.

#### 5. CREDIT STRUCTURE

NSQF Level	Skill Component	General	Normal	Exit Points/
	Credits	Educational	Calendar	Awards
		Credits	Duration	
Year 3	36	24	Six Semester	B. Voc.
Year 2	36	24	Four Semester	Advanced Diploma
Year 1	36	24	Two Semester	Diploma
Total	108	72		

#### 6. The class structure and pattern of the examination

- The Number of students in a theory class shall not exceed 25.
- Maximum number of students in a batch for practical in first four semesters shall consist of 20 students and for fifth & sixth semester the batch shall consist of 15 students.
- The rules for admission to the subsequent (next) semesters will be the same as per the University guidelines.
- The Theory (ESE) and Practical Examinations will be conducted by the University at the end of each semester.
- The marks of internal (IA) and practical exam (ESE) should be submitted to
   University in the prescribed format.
- Assessment of skill component should be done by sector skill council or industry partner.

#### 7. PROGRAMME STRUCTURE

# Semester I

Sr. No	Course Code	Name of the Course		eachi schem	_		Evaluati Schem		Credits	Total
			L	T	P	IA	MSE	ESE	1	Marks
Gen	eral Education			•	II.	ч	1	·!	•	•
			The	eory						
1	BVEMC101	Electronic Measurement and Instrumentation –I	3	0	0	10	0	40	3	50
2	BVEMC102	Identification of Components, Tools, SOP & Work Instructions-I	3	0	0	10	0	40	3	50
3	BVEMC103	Tools, Equipment & Safety Measures –I	3	0	0	10	0	40	3	50
4	BVEMC104	Soldering & De-Soldering of Components –I	3	0	0	10	0	40	3	50
		Total	•	•	•	•	•	•	12	200
Skil	l Components								•	•
		L	ab/Pr	actica	ıl					
5	BVEML105	Identification of Components, Tools, Equipment and its working -Lab	0	0	1	25	0	25	1.5	50
6	BVEML106	Electronic Measurement and Instrumentation -I –Lab	0	0	1	25	0	25	1.5	50
		On-Job-Training (OJ)	Γ)/Qu	alifica	tion l	Packs	(Any O	ne)	Group C	GEM1
7	BVEME117	Embedded Software Engineer (ELE/Q1501)								
8	BVEME128	Security Pack-security surveillance and access control supervisor (ELE/Q4611)	200 15 200							
9	BVEME139	Systems Analyst (ELE/Q8701)								
		Total							18	300

# Semester II

Sr.			T	eachi	ng		Evaluati	on		Total
No	<b>Course Code</b>	Name of the Course	5	scheme Scheme					Credits	
•			L	T	P	IA	MSE	ESE	1	Marks
Gen	eral Education		1	II.		1	•	II.	•	
			The	ory						
1	BVEMC201	Electronic Measurement and Instrumentation –II	3	0	0	10	0	40	3	50
2	BVEMC202	Identification of Components, Tools, SOP & Work Instructions-II	3	0	0	10	0	40	3	50
3	BVEMC203	Tools, Equipment & Safety Measures –II	3	0	0	10	0	40	3	50
4	BVEMC204	Soldering & De-Soldering of Components & Emergency actions II	3	0	0	10	0	40	3	50
		Total	•		•	•			12	200
Skil	l Components								•	
		L	ab/Pr	actica	ıl					
5	BVEML205	Soldering & De-Soldering of Components-Lab	0	0	1	25	0	25	1.5	50
6	BVEML206	Electronic Measurement and Instrumentation -II Lab	0	0	1	25	0	25	1.5	50
		On-Job-Training (OJ7	Fraining (OJT)/Qualification Packs (Any One)						Group C	GEM2
7	BVEME217	Smartphone Repair Technician (ELE/Q8104)								
8	BVEME228	Business Development Executive (ELE/Q1101)	200						15	200
		Total							18	300

# Semester III

Sr.	Course Code	Name of the Course		eachi schem	_	-	Evaluati Schem	_	Credits	Total
No.			L	T	P	IA	MSE	ESE	_	Marks
Gene	ral Education		1	1	1		1	I	•	l
			The	ory						
1	BVEMC301	Fault analysis & Repairs	3	0	0	10	0	40	3	50
2	BVEMC302	Good Manufacturing Concept & Practices – I	3	0	0	10	0	40	3	50
3	BVEMC303	Electronics Devices Circuit  –I	3	0	0	10	0	40	3	50
	BVEMC304	Electronics System Packaging and Manufacturing	3	0	0	10	0	40	3	50
		Total	ı	1	1	1		I	12	200
Skill	Components									
		L	ab/Pr	actica	ıl					
4	BVEML305	Electronics Devices Circuit  –I Lab	0	0	1	25	0	25	1.5	50
	BVEML306	Fault analysis & Repairs - Lab	0	0	1	25	0	25	1.5	50
		On-Job-Training (OJT	`)/Qu	alifica	tion I	Packs	(Any O	ne)		
5	BVEME317	Field Engineer RACW (ELE/Q3105)								
6	BVEME328	Security System Service Engineer (ELE/Q4610)	200							
7	BVEME339	Pre-Sales Solar Technical Support Engineer (ELE/Q5602)	200						13	200
		Total							18	300

# Semester IV

Sr. No.	Course Code	Name of the Course		eachi schem	0		Evaluati Schem	_	Credits	Total Marks
NO.			L	T	P	IA	MSE	ESE		Marks
Gene	ral Education									
			The	eory						
1	BVEMC401	Good Manufacturing Concepts Practices–II	3	0	0	10	0	40	3	50
2	BVEMC402	Manufacturing & Quality Norms	3	0	0	10	0	40	3	50
3	BVEMC403	Good Manufacturing Concepts & Practices–III	3	0	0	10	0	40	3	50
4	BVEMC404	Electronics Devices Circuit –II	3	0	0	10	0	40	3	50
		Total					•	II.	12	200
Skill	Components									l
5	BVEML405	Electronics Devices Circuit –II Lab	0	0	1	25	0	25	1.5	50
6	BVEML406	Manufacturing Practices	0	0	1	25	0	25	1.5	50
		On-Job-Training (OJT)/Q	ualifi	cation	Pack	ks ( Aı	ny One)			
7	BVEME417	Purchase Executive (ELE/Q5701)								
8	BVEME428	Quality Engineer (ELE/Q7901)	200 15 20						200	
		Total							18	300

# Semester V

Sr. No.	Course Code	Name of the Course		Ceachi schem	0		Evaluati Schem	_	Credits	Total Marks
110.			L	T	P	IA	MSE	ESE		Marks
Gene	ral Education			•	•					
			The	eory						
1	BVEMC501	Valuation & Storage	3	0	0	10	0	40	3	50
2	BVEMC502	Shelf Life, Ware House Operations Management & Material Transactions	3	0	0	10	0	40	3	50
3	BVEMC503	Industrial Electronics Product Design	3	0	0	10	0	40	3	50
4	BVEMC504	Pre-Production Activities	3	0	0	10	0	40	3	50
		Total	•			•	•	•	12	200
Skill	Components									
5	BVEML505	Pre-Production Activities- Lab	0	0	1	25	0	25	1.5	50
6	BVEML506	Valuation & Storage-Lab	0	0	1	25	0	25	1.5	50
		On-Job-Training (OJT)/Q	ualifi	ication	ı Pacl	ks ( Aı	ny One)			
7	BVEME517	Product Engineer (ELE/Q4201)								
8	BVEME528	Incoming QC Technician (ELE/Q4401)	200 15 200							
9	BVEME539	Assembly Supervisor (ELE/Q6305)								
		Total							18	300

# Semester VI

Sr. No.	Course Code	Name of the Course		Teaching scheme			<b>Evaluation Scheme</b>			Total Marks
NO.			L	T	P	IA	MSE	ESE		Marks
Gene	ral Education									
			The	eory						
1	BVEMC601	Entrepreneurship/Accountin g/Management	3	1	0	20	0	80	3	100
		Total							3	100
Skill	Components									
		I	ab/Pi	ractic	al					
2	BVEML602	Project Work	0	0	4	100	0	100	12	200
		On-Job-Training (OJ	T)/Qu	alific	ation	Packs (	Any On	e)		
3	BVEME613	FPGA Design Engineer (ELE/Q8201)								
4	BVEME624	Sales Executive-Consumer Electronics (ELE/Q3201)	200 15 200							200
		Total							27	400